



PS-1774

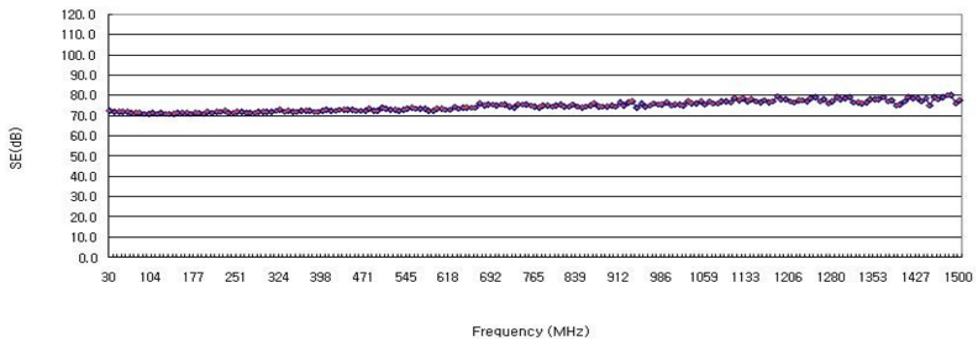
Product Description:

P-SHIELD® PS-1774 is a thin, conductive copper foil with a conductive acrylic adhesive for shielding/grounding applications as well as providing thermal protection to sensitive electronic components.

Construction / Properties:

Property	Value	Test Method
Total Thickness	0.05 mm	QSP-726
Foil	Copper	--
Adhesive Peel Strength (to SUS)	>1000 g/25mm	QSP-722
Surface Resistivity	<0.02 Ω/sq	QSP-741
Z-Axis Resistance	<0.02 Ω/in ²	QSP-741
Shielding Effectiveness (10 MHz- 100 GHz)	70 – 100 dB	--
Recommended Application Specification	2 kg/square inch for 2 seconds	--
Continuous Use Conditions	15 – 70 C	WI-8.2-13

Shielding Effectiveness:



Specific tests should be performed by the end user to determine the product suitability for the particular application.

For Additional Information:

E-Mail: sales@polymerscience.com

Toll Free: +1 888.533.7004

Web: www.polymerscience.com

Revision: 050115



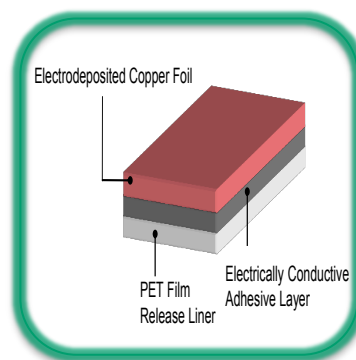
PS-1774

Product Description:

P-SHIELD® PS-1774 is a thin, conductive copper foil with a conductive acrylic adhesive for shielding/grounding applications as well as providing thermal protection to sensitive electronic components.

Features

- Superior Converting Properties
- Excellent Conformability
- Good Durability
- Excellent Shielding Effectiveness
- RoHS and HF Compliant



Specific tests should be performed by the end user to determine the product suitability for the particular application.

For Additional Information:

E-Mail: sales@polymerscience.com

Toll Free: +1 888.533.7004

Web: www.polymerscience.com

Revision: 050115